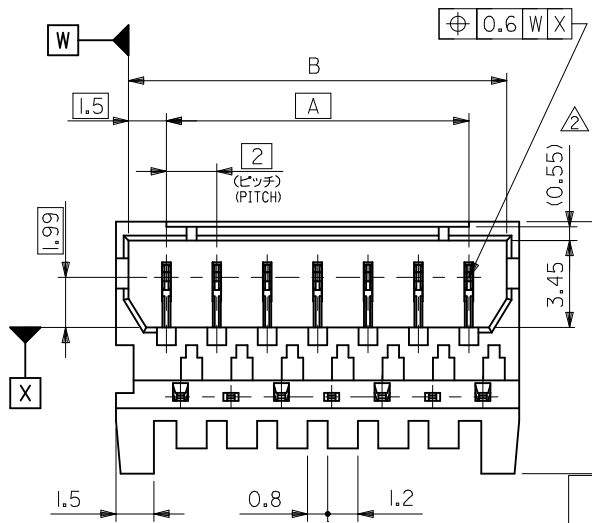


基板取付穴推奨寸法 (マウント面)
RECOMMENDED P.C.BOARD HOLE DIMENSION (MOUNTING SIDE)

注記 NOTES

- 1 嵌合相手: 51004-***00
MATES WITH : 51004-***00
 - 2 6極以上にのみ適用する。
DOTTED LINE TYPICAL 6 THRU
12 CIRCUIT WAFER ONLY.
 - 3 3極このみ適用する。
3 CIRCUIT WAFER ONLY.
 - 4 ロック窓は、2及び3極に1個
4極以上は、2個とする。
ONE LOOKING WINDOW, FOR 2&3CKT.
TWO LOOKING WINDOW, FOR 4CKT. &
MORE THAN 4CKT.
 - 5 成形材料 RESIN MATERIAL
ASAHI CHEMICAL INDUSTRY CO.,LTD
66NYLON FG101 UL94V-0
UL FILE NO.E48285
- △ キングはトレードマーク側から見て奇数極につける事
KINK TO BE ADDED ON THE ODD NUMBER
SOLDER TAILS. (FROM THE TRADE MARK
SIDE)



E	D	C	B	A	53025-1210	12
25.5	22	26	25	22	53025-1210	12
23.5	20	24	23	20	-1110	11
21.5	18	22	21	18	-1010	10
19.5	16	20	19	16	-0910	9
17.5	14	18	17	14	-0810	8
15.5	12	16	15	12	-0710	7
13.5	10	14	13	10	-0610	6
11.5	8	12	11	8	-0510	5
9.5	6	10	9	6	-0410	4
7.5	4	8	7	4	-0310	3
5.5	2	6	5	2	53025-0210	2
E	D	C	B	A	ENG. NO.	CKT.

REVISED EC NO: JTR2011-0119 DRW:SHIBATA 2011/08/18 CHKD:KOMATSU 2011/08/18 APPR: MAYAMOTO 2011/08/31	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.20	DRAWN BY M. NAKAMURA	DATE 1994/08/19	TITLE 2.0 LOW PROFILE CONN WAFER ASSY (B/E TYPE)		
	10 OVER 30 UNDER	±0.25	CHECKED BY H. HIRAMOTO	DATE 1994/08/20	MOLEX INCORPORATED		
	30 OVER	±0.30	APPROVED BY M. FUKUSHIMA	DATE 1994/08/20	DOCUMENT NO. SD-53025-***10	SHEET NO. 1 OF 1	
REV	DESCRIPTION	ANGULAR ±3 °	SEE CHART		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							